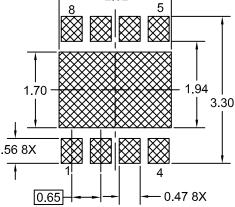


WDFN8 3x3, 0.65P CASE 511DD ISSUE O

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- B. DIMENSIONS ARE IN MILLIMETERS.
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